

Features

- Uses advanced SGT technology
- Extremely low on-resistance $R_{DS(on)}$
- Excellent gate charge x $R_{DS(on)}$ product(FOM)

Application

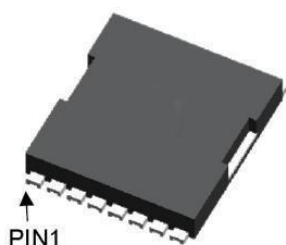
- Motor control and drive
- Battery management
- DC/DC

Product Summary

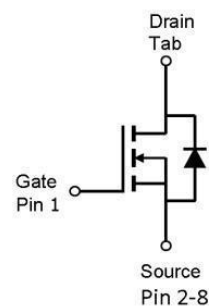
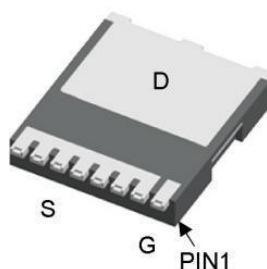
Package	TOLL
V_{DS}	60V
$R_{DS(on)}@V_{GS}=10V$	2.4mΩ
I_D	136A

Package Marking

TOLL Top View



TOLL Bottom View



Type	Package	Marking	Reel Size	Tape Width	Packing	Qty
LR028N06SWL10	TOLL	LR028N06SWL10	330*28.5mm	24mm	Reel&Tape	2000

Maximum Ratings (TC=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous drain current $T_c=25^{\circ}C$ (Silicon limit) $T_c=100^{\circ}C$ (Silicon limit)	I_D	136 86	A
Pulsed Drain Current	I_{DM}	320	A
Maximum Power Dissipation	P_d	90	W
Single pulse avalanche energy	E_{AS}	649	mJ
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 150	°C

Thermal Characteristic

Thermal Resistance,Junction-to-Case	R_{thJC}	1.39	°C/W
-------------------------------------	------------	------	------

Electrical Characteristics (T_c=25°C unless otherwise noted)

Parameter	Symbol	Condition	min	typ	max	Unit
-----------	--------	-----------	-----	-----	-----	------

Static Characteristic

Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	60	-	-	V
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.2	1.7	2.2	
Zero gate voltage drain current	I_{DSS}	$V_{DS}=60V, V_{GS}=0V$	-	-	1	μA
Gate-source leakage current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	±100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$I_D=20A, V_{GS}=10V$	-	2.4	2.8	mΩ

Dynamic Characteristic

Input Capacitance	C_{iss}	$V_{DS}=30V, V_{GS}=0V,$ $f=1MHz$	-	3734	-	pF
Output Capacitance	C_{oss}		-	1836	-	
Reverse Transfer Capacitance	C_{rss}		-	83	-	
Gate resistance	R_g	$f=1MHz$	-	2.2	-	Ω
Gate Total Charge	Q_G	$V_{DS}=30V, I_D=20A,$ $V_{GS}=10V$	-	54	-	nC
Gate-Source charge	Q_{gs}		-	10	-	
Gate-Drain charge	Q_{gd}		-	8	-	
Turn-on delay time	$t_{d(on)}$	$V_{GS}=10V, V_{DS}=30V,$ $R_G=1.6\Omega$	-	12	-	ns
Rise time	t_r		-	47	-	
Turn-off delay time	$t_{d(off)}$		-	47	-	
Fall time	t_f		-	58	-	

Body Diode Characteristic

Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=20A$	-	-	1.2	v
Reverse Recovery Time	t_{rr}	$I_F = 20A$ $di/dt = 100A/\mu s$	-	34	-	ns
Reverse Recovery Charge	Q_{rr}		-	100	-	nC

Typical Performance Characteristics

Fig 1: Output Characteristics

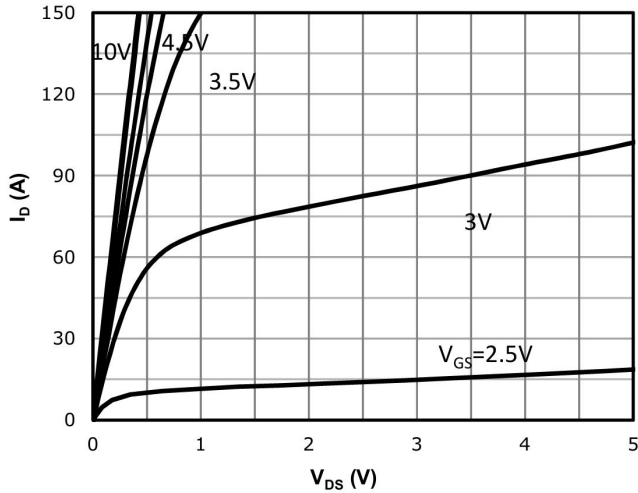


Fig 2: Transfer Characteristics

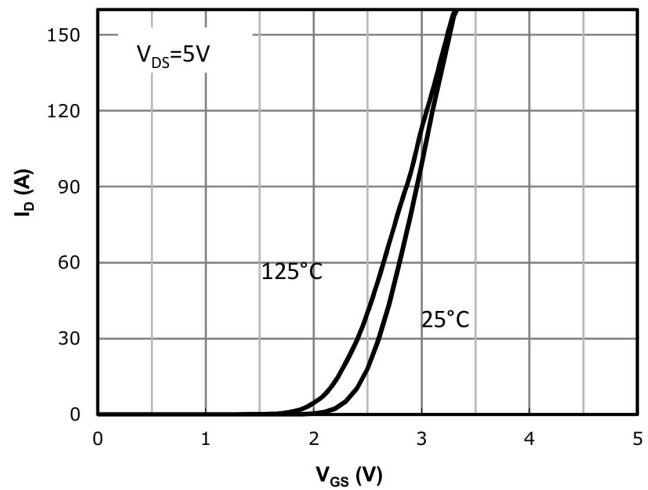


Fig 3: $R_{DS(on)}$ vs Drain Current and Gate Voltage

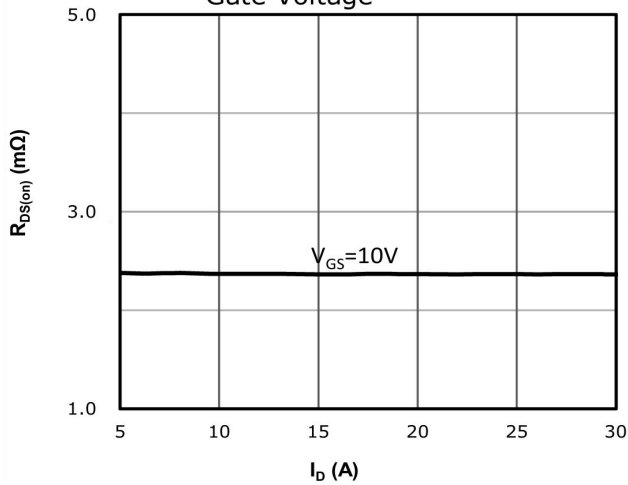


Fig 4: $R_{DS(on)}$ vs Gate Voltage

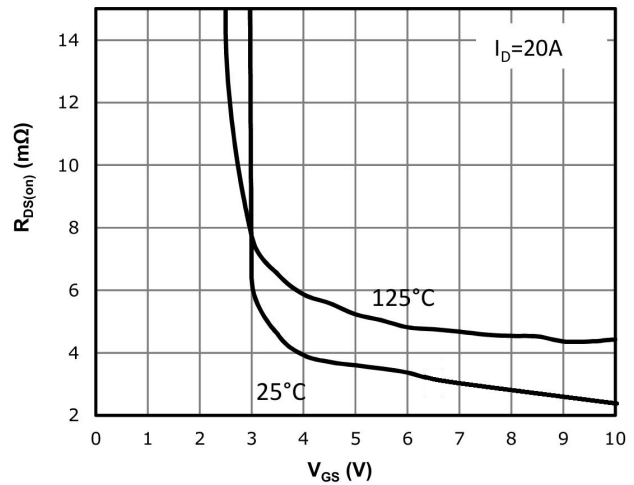


Fig 5: $R_{DS(on)}$ vs. Temperature

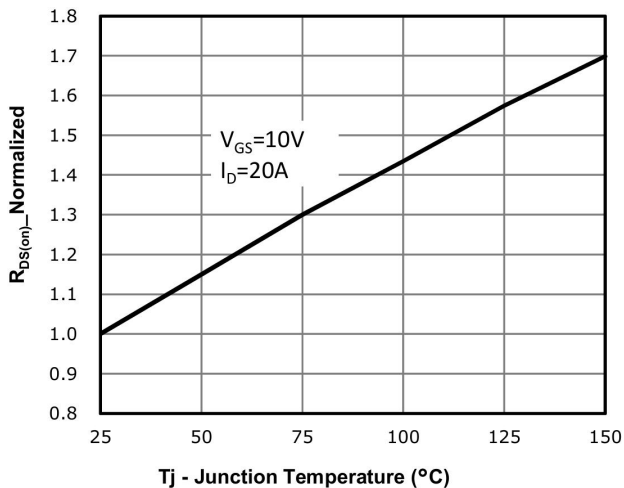


Fig 6: Capacitance Characteristics

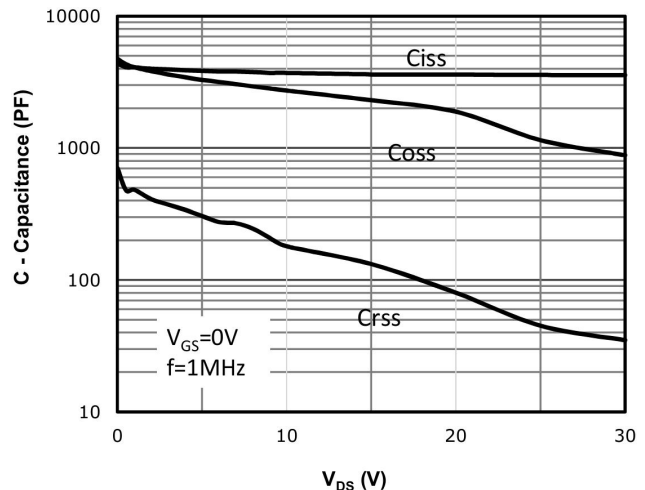


Fig 7: Gate Charge Characteristics

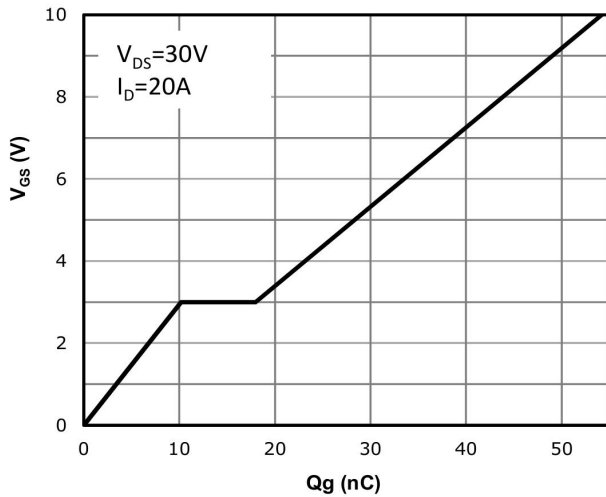


Fig 8: Body-diode Forward Characteristics

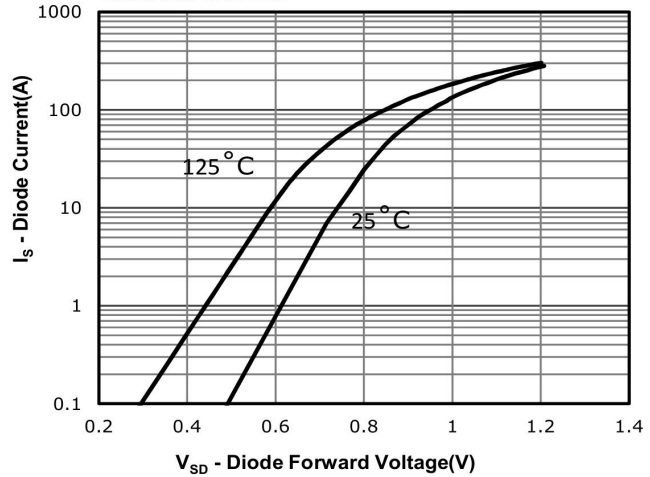


Fig 9: Power Dissipation

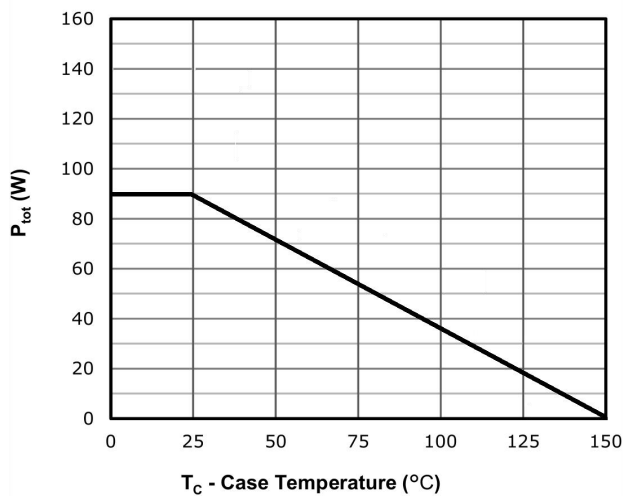


Fig 10: Drain Current Derating

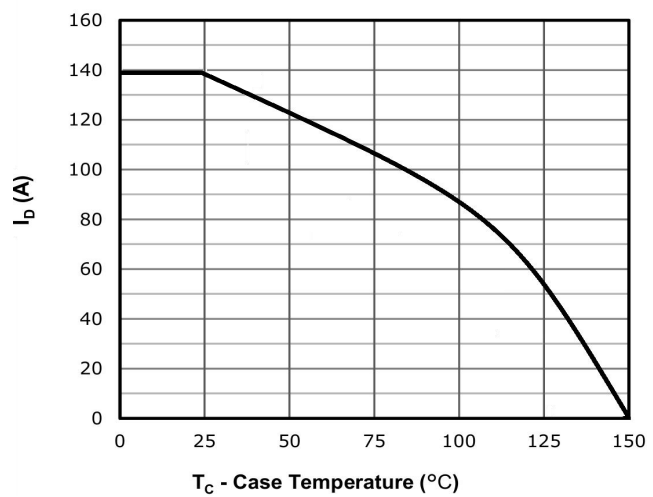


Fig 11: BVdss vs. Temperature

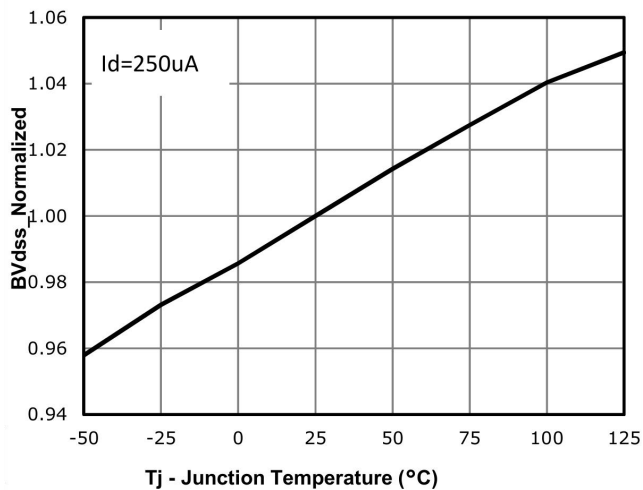


Fig 12: Vgs(th) vs. Temperature

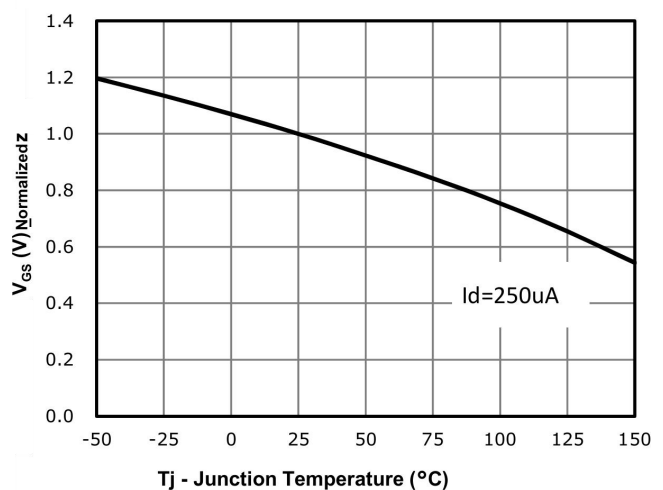


Fig 13: Safe Operating Area

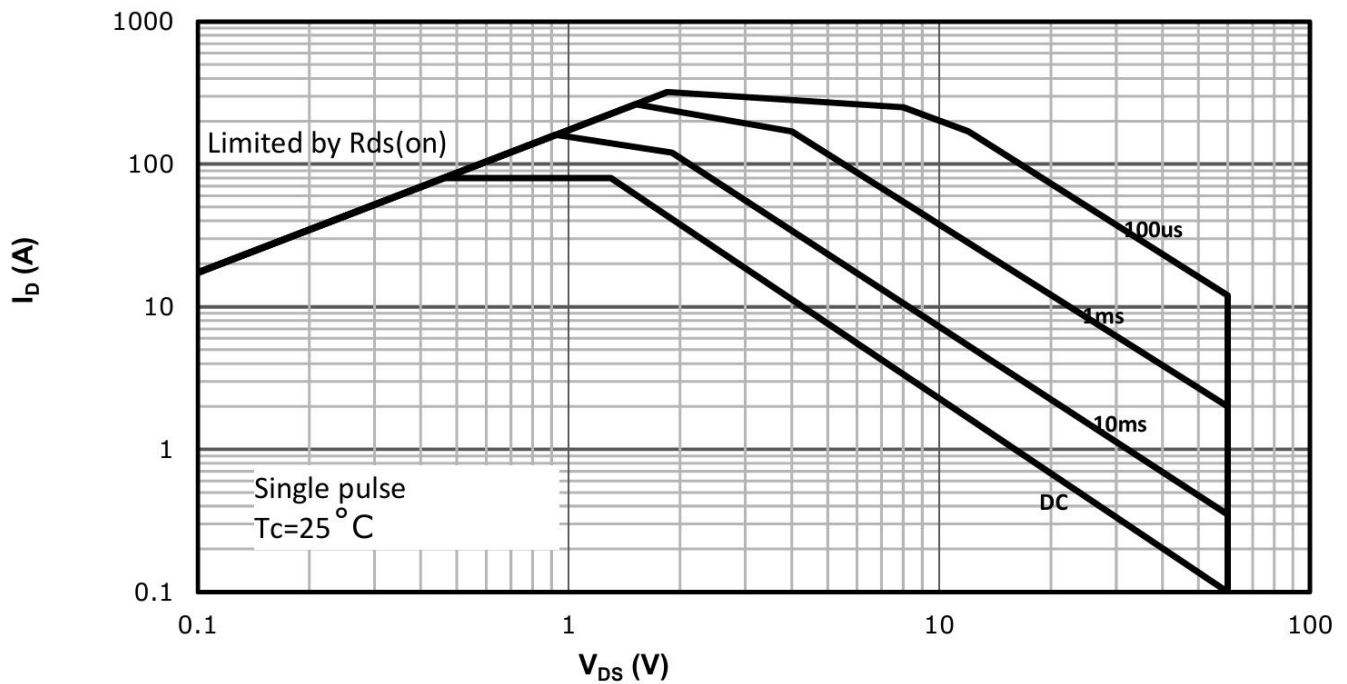
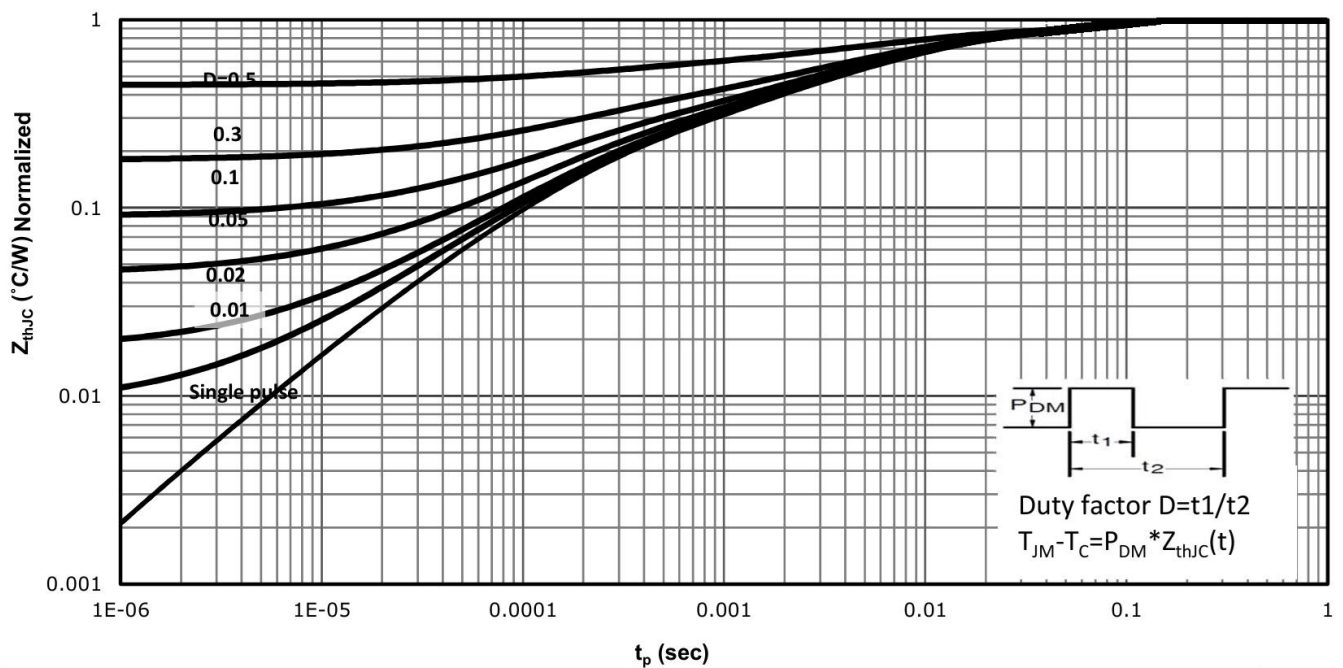
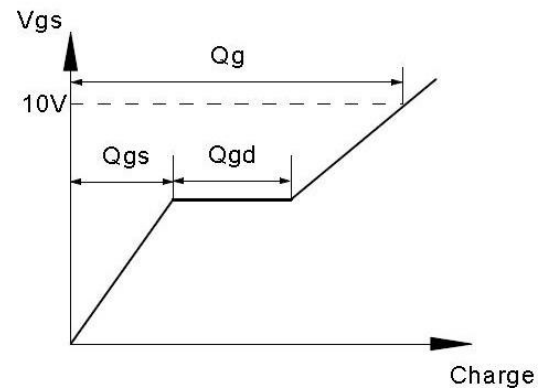
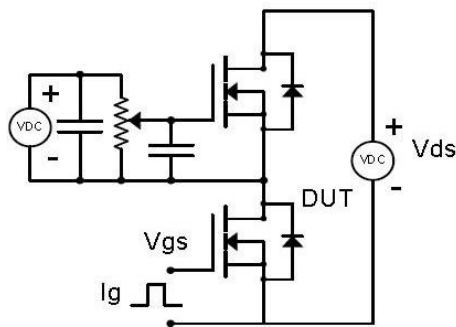


Fig 14: Max. Transient Thermal Impedance

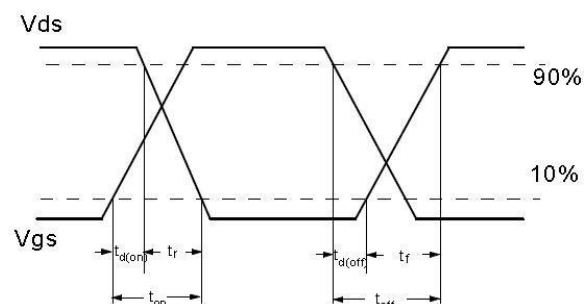
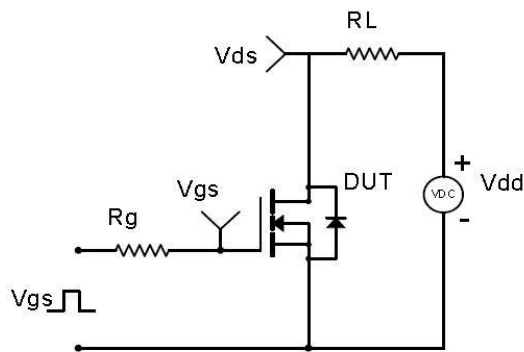


Test Circuit & Waveform

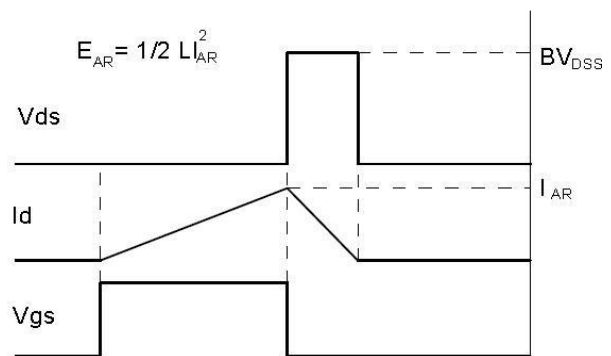
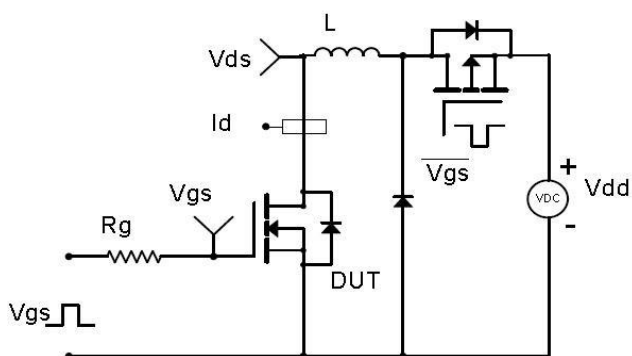
Gate Charge Test Circuit & Waveform



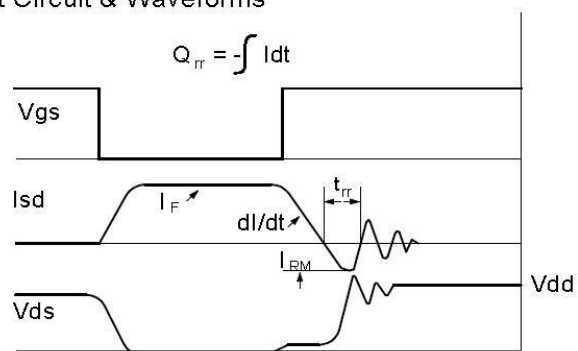
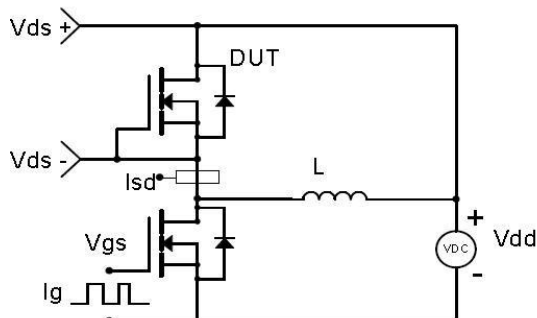
Resistive Switching Test Circuit & Waveforms



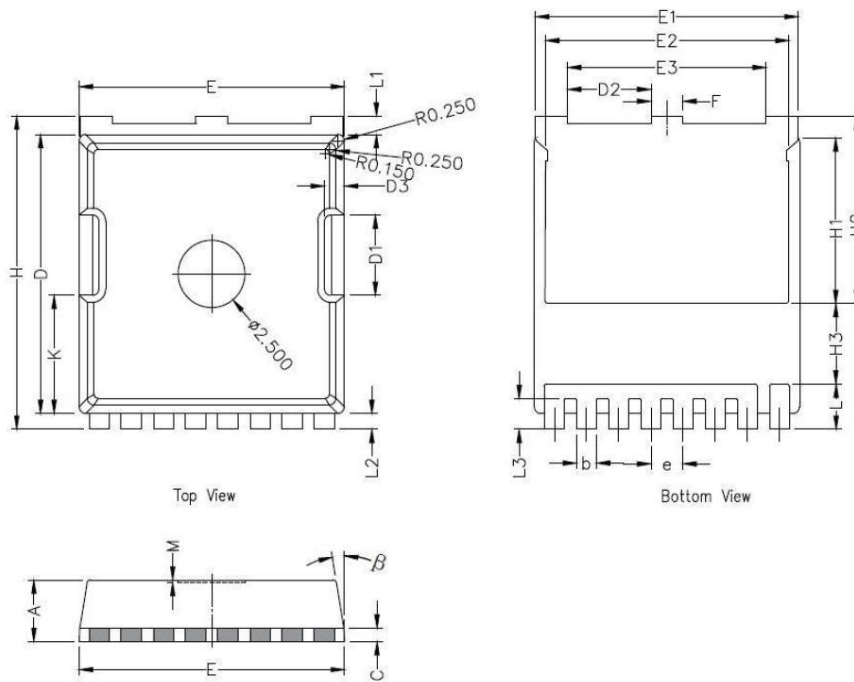
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



Package Outline:TOLL



Symbols	Millimeters		
	MIN.	NOM.	MAX.
A	2.20	2.30	2.40
b	0.65	0.75	0.85
C	0.508 REF		
D	10.25	10.40	10.55
D1	2.85	3.00	3.15
D2	2.95	3.10	3.25
D3	0.75 REF		
E	9.75	9.90	10.05
E1	9.65	9.80	9.95
E2	8.95	9.10	9.25
E3	7.25	7.40	7.55
e	1.20 BSC		
F	1.05	1.20	1.35
H	11.55	11.70	11.85
H1	6.03	6.18	6.33
H2	6.85	7.00	7.15
H3	3.00 BSC		
L	1.55	1.70	1.85
L1	0.55	0.70	0.85
L2	0.45	0.60	0.75
L3	1.00	1.15	1.30
M	0.08 REF		
β	8°	10°	12°
K	4.25	4.40	4.55

Revision History:

Revision	Date	Major changes
1.0	2024/8/7	Release of Preliminary version.
2.0	2026/4/1	Update Typical Performance Characteristics.